## Single Digitally-Controlled (XDCP™) Potentiometer

The X9119 integrates a single digitally controlled potentiometer (XDCP™) on a monolithic CMOS integrated circuit.

The digital controlled potentiometer is implemented using 1023 resistive elements in a series array. Between each element are tap points connected to the wiper terminal through switches. The position of the wiper on the array is controlled by the user through the 2-wire bus interface. The potentiometer has associated with it a volatile Wiper Counter Register (WCR) and a four non-volatile Data Registers that can be directly written to and read by the user. The contents of the WCR controls the position of the wiper on the resistor array though the switches. Powerup recalls the contents of the default data register (DR0) to the WCR.

The XDCP™ can be used as a three-terminal potentiometer or as a two terminal variable resistor in a wide variety of applications including control, parameter adjustments, and signal processing.

## Features

- 1024 Resistor Taps – 10-Bit Resolution

- 2-Wire Serial Interface for Write, Read, and Transfer Operations of the Potentiometer

- Wiper Resistance, 40Ω Typical @ $V_{CC}$ = 5V

- Four Non-Volatile Data Registers

- Non-Volatile Storage of Multiple Wiper Positions

- Power-on Recall. Loads Saved Wiper Position on Power-up.

- Standby Current < 3µA Max

- $V_{CC}$: 2.7V to 5.5V Operation

- 100kΩ End-to-End Resistance

- 100 yr. Data Retention

- Endurance: 100,000 Data Changes Per Bit Per Register

- 14 Ld TSSOP

- Low Power CMOS

- Single Supply Version of the X9118

- Pb-Free available (RoHS compliant)

## Functional Diagram
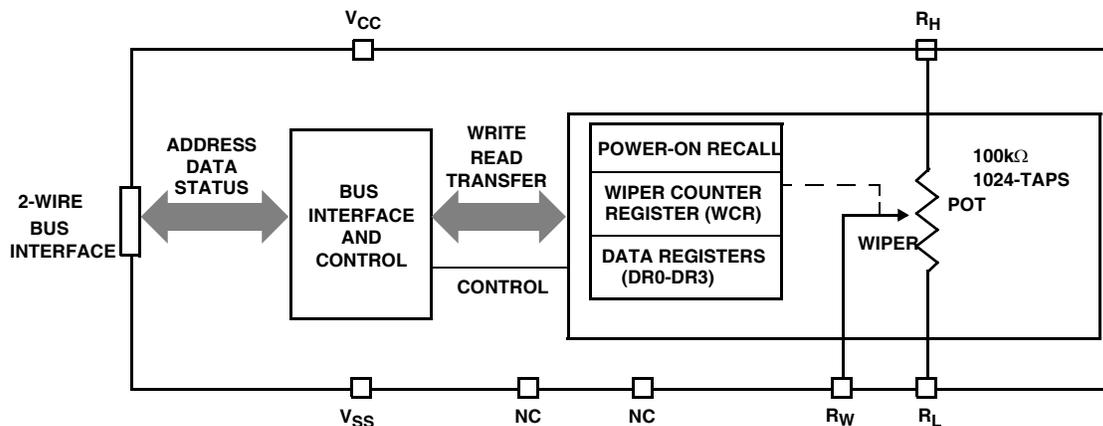
## *Ordering Information*

| PART NUMBER | PART MARKING | V$_{CC}$ LIMITS (V) | POTENTIOMETER ORGANIZATION (kΩ) | TEMP RANGE (°C) | PACKAGE | PKG. DWG.# |
|---|---|---|---|---|---|---|
| X9119TV14I | X9119 TVI | 5 ±10% | 100 | -40 to +85 | 14 Ld TSSOP (4.4mm) | M14.173 |
| X9119TV14IZ (Note) | X9119 TVZI | | | -40 to +85 | 14 Ld TSSOP (4.4mm) (Pb-free) | M14.173 |
| X9119TV14 | X9119 TV | | | 0 to +70 | 14 Ld TSSOP (4.4mm) | M14.173 |
| X9119TV14Z (Note) | X9119 TVZ | | | 0 to +70 | 14 Ld TSSOP (4.4mm) (Pb-free) | M14.173 |
| X9119TV14-2.7* | X9119 TVF | 2.7 to 5.5 | | 0 to +70 | 14 Ld TSSOP (4.4mm) | M14.173 |
| X9119TV14Z-2.7* (Note) | X9119 TVZF | | | 0 to +70 | 14 Ld TSSOP (4.4mm) (Pb-free) | M14.173 |
| X9119TV14I-2.7 | X9119 TVG | | | -40 to +85 | 14 Ld TSSOP (4.4mm) | M14.173 |
| X9119TV14IZ-2.7* (Note) | X9119 TVZG | | | -40 to +85 | 14 Ld TSSOP (4.4mm) (Pb-free) | M14.173 |

*Add "T1" suffix for tape and reel. Please refer to TB347 for details on reel specifications.

NOTE: These Intersil Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

## *Detailed Functional Diagram*
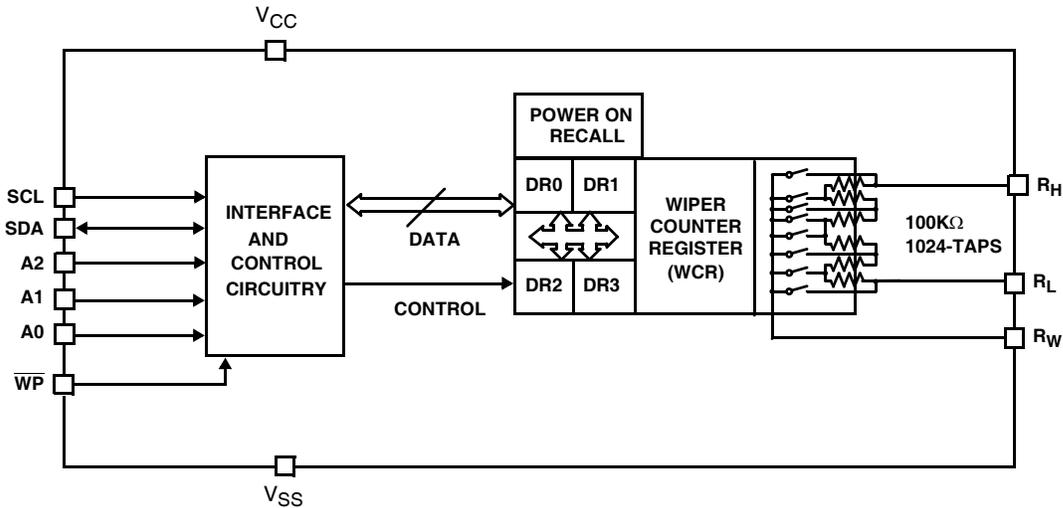
## *Applications*

### *Circuit Level*

• Vary the gain of a voltage amplifier

• Provide programmable DC reference voltages for comparators and detectors

• Control the volume in audio circuits

• Trim out the offset voltage error in a voltage amplifier circuit

• Set the output voltage of a voltage regulator

• Trim the resistance in Wheatstone bridge circuits

• Control the gain, characteristic frequency and Q-factor in filter circuits

• Set the scale factor and zero point in sensor signal conditioning circuits

• Vary the frequency and duty cycle of timer ICs

• Vary the DC biasing of a pin diode attenuator in RF circuits

• Provide a control variable (I, V, or R) in feedback circuits

### *System Level*

• Adjust the contrast in LCD displays

• Control the power level of LED transmitters in communication systems

• Set and regulate the DC biasing point in an RF power amplifier in wireless systems

• Control the gain in audio and home entertainment systems

• Provide the variable DC bias for tuners in RF wireless systems

• Set the operating points in temperature control systems

• Control the operating point for sensors in industrial systems

• Trim offset and gain errors in artificial intelligent systems

## *Pinout*

**X9119**
**(14 LD TSSOP)**
TOP VIEW

```
        ┌────────┐
NC  ─┤ 1      14 ├─ V_CC
A0  ─┤ 2      13 ├─ R_L
NC  ─┤ 3      12 ├─ R_H
A2  ─┤ 4      11 ├─ R_W
SCL ─┤ 5      10 ├─ NC
SDA ─┤ 6       9 ├─ A1
V_SS─┤ 7       8 ├─ WP
        └────────┘
```
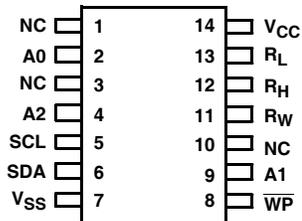
## *Pin Assignments*

| PIN NUMBER | PIN NAME | FUNCTION |
|---|---|---|
| 1, 3, 10 | NC | No Connect |
| 2 | A0 | Device Address for 2-wire bus |
| 4 | A2 | Device Address for 2-wire bus |
| 5 | SCL | Serial Clock for 2-wire bus |
| 6 | SDA | Serial Data Input/Output for 2-wire bus |
| 7 | $V_{SS}$ | System Ground |
| 8 | $\overline{WP}$ | Hardware Write Protect |
| 9 | A1 | Device Address for 2-wire bus |
| 11 | $R_W$ | Wiper terminal of the Potentiometer |
| 12 | $R_H$ | High terminal of the Potentiometer |
| 13 | $R_L$ | Low terminal of the Potentiometer |
| 14 | $V_{CC}$ | System Supply Voltage |

### *Bus Interface Pins*

#### SERIAL DATA INPUT/OUTPUT (SDA)

The SDA is a bidirectional serial data input/output pin for a 2-wire slave device and is used to transfer data into and out of the device. It receives device address, opcode, wiper register address and data sent from an 2-wire master at the rising edge of the serial clock SCL, and it shifts out data after each falling edge of the serial clock SCL.

It is an open drain output and may be wire-ORed with any number of open drain or open collector outputs. An open drain output requires the use of a pull-up resistor. For selecting typical values, refer to the guidelines for calculating typical values on the bus pull-up resistors graph.

#### SERIAL CLOCK (SCL)

This input is used by 2-wire master to supply 2-wire serial clock to the X9119.

#### DEVICE ADDRESS ($A_2$–$A_0$)

The Address inputs are used to set the least significant 3 bits of the 8-bit slave address. A match in the slave address serial data stream must be made with the Address input in order to initiate communication with the X9119. A maximum of 8 devices may occupy the 2-wire serial bus.

#### HARDWARE WRITE PROTECT INPUT ($\overline{WP}$)

The $\overline{WP}$ pin when LOW prevents nonvolatile writes to the Data Registers.

### *Potentiometer Pins*

#### $R_H$, $R_L$

The $R_H$ and $R_L$ pins are equivalent to the terminal connections on a mechanical potentiometer.

**R$_W$**

The wiper pin are equivalent to the wiper terminal of a mechanical potentiometer.

## *Bias Supply Pins*

### SYSTEM SUPPLY VOLTAGE (V$_{CC}$) AND SUPPLY GROUND (V$_{SS}$)

The V$_{CC}$ pin is the system supply voltage. The V$_{SS}$ pin is the system ground.

## *Other Pins*

### NO CONNECT

No connect pins should be left open. These pins are used for Intersil manufacturing and testing purposes.

### *Principals of Operation*

The X9119 is an integrated microcircuit incorporating a resistor array and its associated registers and counters and the serial interface logic providing direct communication between the host and the digitally controlled potentiometer. This section provides detail description of the following:

- Resistor Array Description
- Serial Interface Description
- Instruction and Register Description

### *Resistor Array Description*

The X9119 is comprised of a resistor array. The array contains, in effect, 1023 discrete resistive segments that are connected in series (Figure 1). The physical ends of each array are equivalent to the fixed terminals of a mechanical potentiometer (R$_H$ and R$_L$ inputs).

At both ends of each array and between each resistor segment is a CMOS switch connected to the wiper (R$_W$) output. Within each individual array only one switch may be turned on at a time. These switches are controlled by the Wiper Counter Register (WCR). The 10-bits of the WCR (WCR[9:0]) are decoded to select, and enable, one of 1024 switches.

The WCR may be written directly. The Data Registers and the WCR can be read and written by the host system.

### *Serial Interface Description*

### SERIAL INTERFACE

The X9119 supports a bidirectional bus oriented protocol. The protocol defines any device that sends data onto the bus as a transmitter and the receiving device as the receiver. The device controlling the transfer is a master and the device being controlled is the slave. The master will always initiate data transfers and provide the clock for both transmit and receive operations. Therefore, the X9119 will be considered a slave device in all applications.

### CLOCK AND DATA CONVENTIONS

Data states on the SDA line can change only during SCL LOW periods. SDA state changes during SCL HIGH are reserved for indicating start and stop conditions (Figure 3).

### START CONDITION

All commands to the X9119 are preceded by the start condition, which is a HIGH to LOW transition of SDA while SCL is HIGH. The X9119 continuously monitors the SDA and SCL lines for the start condition and will not respond to any command until this condition is met (Figure 3).
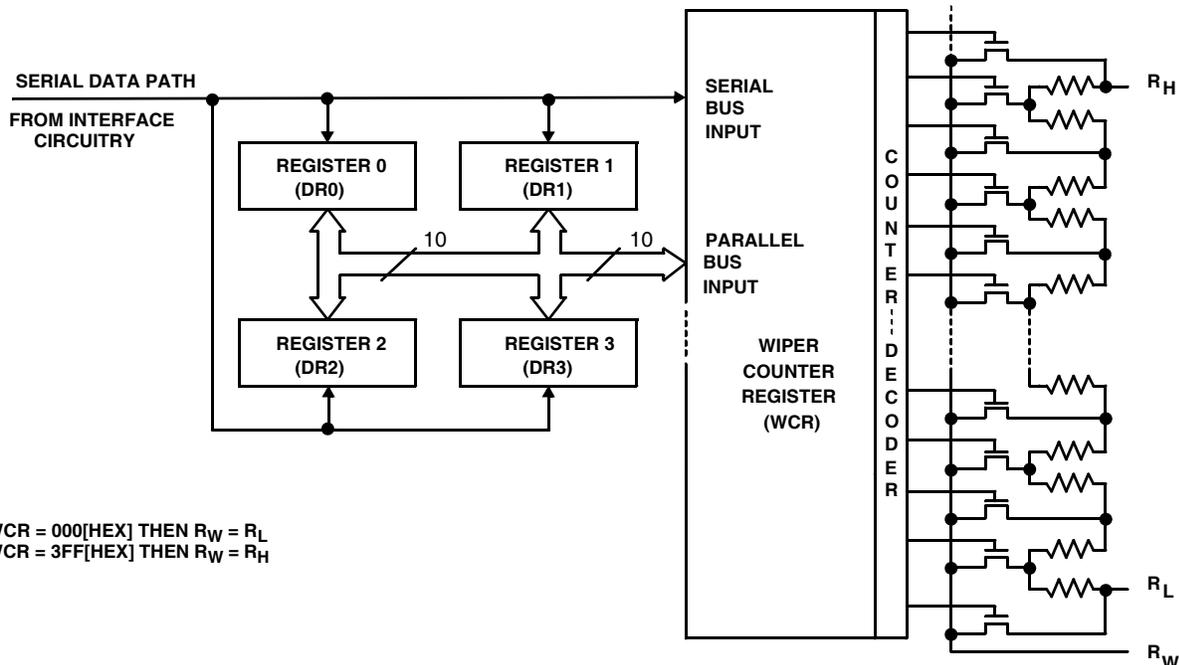


**FIGURE 1.  DETAILED POTENTIOMETER BLOCK DIAGRAM SERIAL INTERFACE DESCRIPTION**

IF WCR = 000[HEX] THEN R$_W$ = R$_L$
IF WCR = 3FF[HEX] THEN R$_W$ = R$_H$

## STOP CONDITION

All communications must be terminated by a stop condition, which is a LOW to HIGH transition of SDA while SCL is HIGH (see Figure 3).

## ACKNOWLEDGE

Acknowledge is a software convention used to provide a positive handshake between the master and slave devices on the bus to indicate the successful receipt of data. The transmitting device, either the master or the slave, will

release the SDA bus after transmitting eight bits. The master generates a ninth clock cycle and during this period the receiver pulls the SDA line LOW to acknowledge that it successfully received the eight bits of data.

The X9119 will respond with an acknowledge after recognition of a start condition and its slave address and once again after successful receipt of the command byte. If the command is followed by a data byte the X9119 will respond with a final acknowledge (see Figure 2).
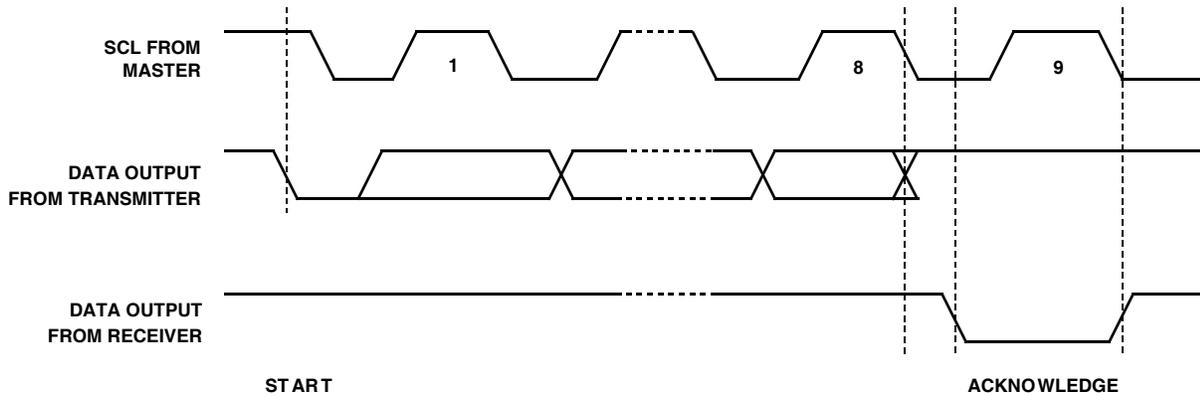


FIGURE 2. ACKNOWLEDGE RESPONSE FROM RECEIVER

## ACKNOWLEDGE POLLING

The disabling of the inputs, during the internal nonvolatile write operation, can be used to take advantage of the typical 5ms EEPROM write cycle time. Once the stop condition is issued to indicate the end of the nonvolatile write command the X9119 initiates the internal write cycle. ACK polling, Flow 1, can be initiated immediately. This involves issuing the start condition followed by the device slave address. If the X9119 is still busy with the write operation, no ACK will be returned. If the X9119 has completed the write operation, an ACK will be returned and the master can then proceed with the next operation.

*FLOW 1. ACK Polling Sequence*
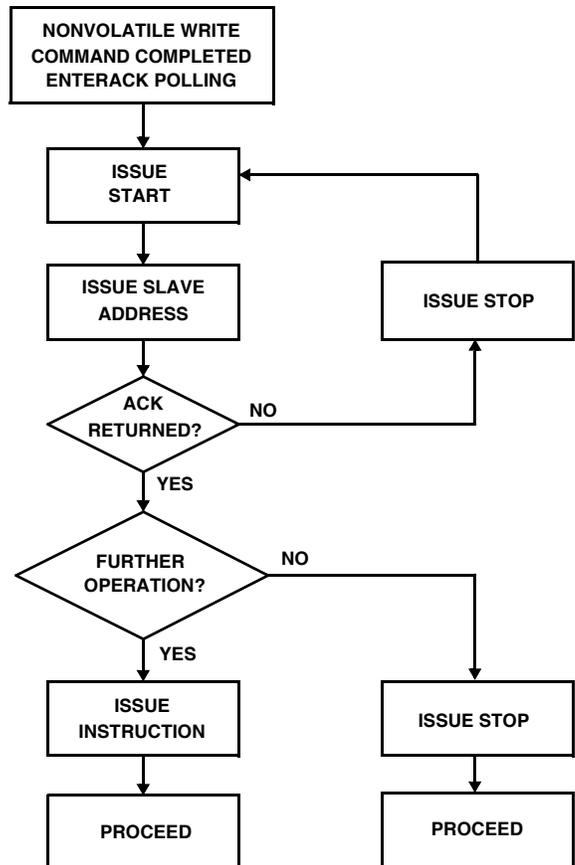
## Instruction and Register Description

### Device Addressing: Identification Byte (ID and A)

Following a start condition, the master must output the address of the slave it is accessing. The most significant four bits of the slave address are the device type identifier. The ID[3:0] bits is the device id for the X9119; this is fixed as 0101[B] (refer to Table 1).

The A2–A0 bits in the ID byte is the internal slave address. The physical device address is defined by the state of the A2–A0 input pins. The slave address is externally specified by the user. The X9119 compares the serial data stream with the address input state; a successful compare of both address bits is required for the X9119 to successfully continue the command sequence. Only the device which slave address matches the incoming device address sent by the master executes the instruction. The A2–A0 inputs can be actively driven by CMOS input signals or tied to $V_{CC}$ or $V_{SS}$. The $R/\overline{W}$ bit is the LSB and is be used to program the device for read or write operations.

### INSTRUCTION BYTE AND REGISTER SELECTION

The next byte sent to the X9119 contains the instruction and register pointer information. The three most significant bits are used provide the instruction opcode (IOP[2:0]). The RB and RA bits point to one of the four registers. The format is shown below in Table 2.

Table 3 provides a complete summary of the instruction set opcodes.

### TABLE 1. IDENTIFICATION BYTE FORMAT

| DEVICE TYPE IDENTIFIES | | | | INTERNAL SLAVE ADDRESS | | | READ OR WRITE BIT |
|---|---|---|---|---|---|---|---|
| ID3 | ID2 | ID1 | ID0 | A2 | A1 | A0 | $R/\overline{W}$ |
| 0 | 1 | 0 | 1 | | | | |
| (MSB) | | | | | | | (LSB) |
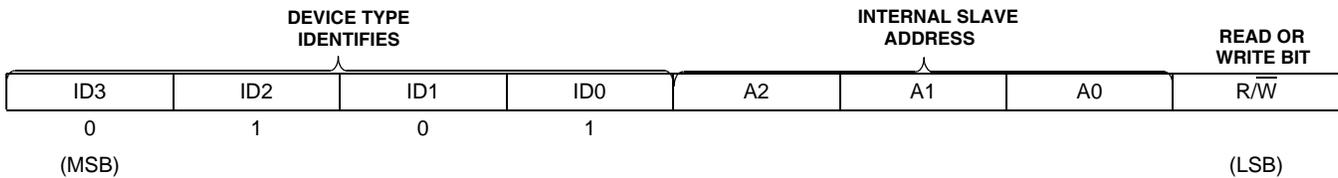
### TABLE 2. INSTRUCTION BYTE FORMAT
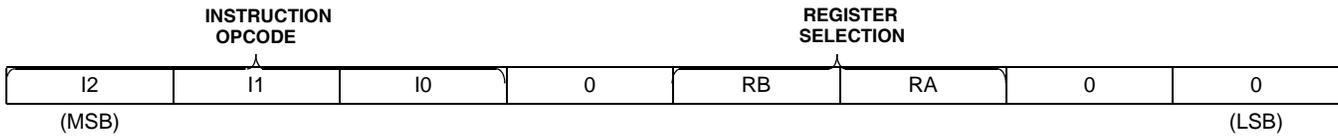
| INSTRUCTION OPCODE | | | | REGISTER SELECTION | | | |
|---|---|---|---|---|---|---|---|
| I2 | I1 | I0 | 0 | RB | RA | 0 | 0 |
| (MSB) | | | | | | | (LSB) |

| REGISTER SELECTED | RB | RA |
|---|---|---|
| DR0 | 0 | 0 |
| DR1 | 0 | 1 |
| DR2 | 1 | 0 |
| DR3 | 1 | 1 |

### TABLE 3. INSTRUCTION SET

| INSTRUCTION | R/W | I₂ | I₁ | I₀ | 0 | RB | RA | 0 | 0 | OPERATION |
|---|---|---|---|---|---|---|---|---|---|---|
| | | $I_2$ | $I_1$ | $I_0$ | 0 | RB | RA | 0 | 0 | |
| Read Wiper Counter Register | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | Read the contents of the Wiper Counter Register |
| Write Wiper Counter Register | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | Write new value to the Wiper Counter Register |
| Read Data Register | 1 | 1 | 0 | 1 | 0 | 1/0 | 1/0 | 0 | 0 | Read the contents of the Data Register pointed to RB-RA. |
| Write Data Register | 0 | 1 | 1 | 0 | 0 | 1/0 | 1/0 | 0 | 0 | Write new value to the Data Register pointed to RB-RA. |
| XFR Data Register to Wiper Counter Register | 1 | 1 | 1 | 0 | 0 | 1/0 | 1/0 | 0 | 0 | Transfer the contents of the Data Register pointed to by RB-RA.to the Wiper Counter Register |
| XFR Wiper Counter Register to Data Register | 0 | 1 | 1 | 1 | 0 | 1/0 | 1/0 | 0 | 0 | Transfer the contents of the Wiper Counter Register to the Data Register pointed to by RB-RA. |

NOTE: 1/0 = data is one or zero.

# Instruction and Register Description

## Device Addressing

### WIPER COUNTER REGISTER (WCR)

The X9119 contains a Wiper Counter Registers (refer to Table 4) for the XDCP potentiometer. The WCR is equivalent to a serial-in, parallel-out register/counter with its outputs decoded to select one of 1024 switches along its resistor array. The contents of the WCR can be altered in one of three ways:

1. it may be written directly by the host via the write wiper counter register instruction (serial load)

2. it may be written indirectly by transferring the contents of one of four associated data registers via the XFR data register

3. it is loaded with the contents of its data register zero (R0) upon power-up.

The Wiper Counter Register is a volatile register; that is, its contents are lost when the X9119 is powered-down.

Although the register is automatically loaded with the value in DR0 upon power-up, this may be different from the value present at power-down. Power-up guidelines are recommended to ensure proper loadings of the DR0 value into the WCR.

### DATA REGISTERS (DR0 TO DR3)

The potentiometer has four 10-bit non-volatile Data Registers. These can be read or written directly by the host. Data can also be transferred between any of the four Data Registers and the Wiper Counter Register. All operations changing data in one of the data registers is a nonvolatile operation and will take a maximum of 10ms.

If the application does not require storage of multiple settings for the potentiometer, the Data Registers can be used as regular memory locations for system parameters or user preference data.

Bit 9–Bit 0 are used to store one of the 1024 wiper position (0 ~1023).

**TABLE 4. WIPER CONTROL REGISTER, WCR (10-BIT), WCR9–WCR0:** Used to store the current wiper position (Volatile, V)

| WCR9 | WCR8 | WCR7 | WCR6 | WCR5 | WCR4 | WCR3 | WCR2 | WCR1 | WCR0 |
|------|------|------|------|------|------|------|------|------|------|
| V | V | V | V | V | V | V | V | V | V |
| (MSB) | | | | | | | | | (LSB) |

**TABLE 5. DATA REGISTER, DR (10-BIT), BIT 9–BIT 0:** Used to store wiper positions or data (Non-Volatile, NV)

| Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|
| NV | NV | NV | NV | NV | NV | NV | NV | NV | NV |
| MSB | | | | | | | | | LSB |

Four of the six instructions are four bytes in length. These instructions are:

• **Read Wiper Counter Register** – read the current wiper position of the selected potentiometer,

• **Write Wiper Counter Register** – change current wiper position of the selected potentiometer,

• **Read Data Register** – read the contents of the selected Data Register;

• **Write Data Register** – write a new value to the selected Data Register.

The basic sequence of the four byte instructions is illustrated in Figure 3. These four-byte instructions exchange data between the WCR and one of the Data Registers. A transfer from a data register to a WCR is essentially a write to a static RAM, with the static RAM controlling the wiper position. The response of the wiper to this action will be delayed by $t_{WRL}$. A transfer from the WCR (current wiper position), to a data register is a write-to-nonvolatile memory and takes a minimum of $t_{WR}$ to complete. The transfer can occur between one of the four potentiometers and one of its associated registers.

Two instructions (Figure 4) require a two-byte sequence to complete. These instructions transfer data between the host and the X9119; either between the host and one of the data registers or directly between the host and the Wiper Counter Register. These instructions are:

• **XFR Data Register to Wiper Counter Register** – This transfers the contents of one specified Data Register to the Wiper Counter Register.

• **XFR Wiper Counter Register to Data Register** – This transfers the contents of the Wiper Counter Register to the specified Data Register.

See "Instruction Format" on page 8 for more details.

### POWER-UP AND DOWN REQUIREMENTS

There are no restrictions on the power-up condition of $V_{CC}$ and the voltages applied to the potentiometer pins provided that the $V_{CC}$ is always more positive than or equal to the voltages at $R_H$, $R_L$, and $R_W$, i.e. $V_{CC} \geq R_H$, $R_L$, $R_W$. There are no restrictions on the power-down condition. However, the datasheet parameters for the DCP do not apply until 1ms after $V_{CC}$ reaches its final value.

**FIGURE 3. TWO-BYTE INSTRUCTION SEQUENCE**



**FIGURE 4. FOUR-BYTE INSTRUCTION SEQUENCE (WRITE OR READ FOR WCR OR DATA REGISTERS)**

## *Instruction Format*

### READ WIPER COUNTER REGISTER (WCR)



### WRITE WIPER COUNTER REGISTER (WCR)



### READ DATA REGISTER (DR)



*intersil*

## WRITE DATA REGISTER (DR)

| START | DEVICE TYPE IDENTIFIER | | | | DEVICE ADDRESSES | | | $R/\overline{W}=0$ | SACK | INSTRUCTION OPCODE | | | | REGISTER ADDRESSES | | | | SACK | WIPER POSITION OR DATA (SENT BY MASTER ON SDA) | | | | | | | | SACK | WIPER POSITION OR DATA (SENT BY MASTER ON SDA) | | | | | | | | SACK | STOP | HIGH-VOLTAGE WRITE CYCLE |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| | 0 | 1 | 0 | 1 | A2 | A1 | A0 | | | 1 | 1 | 0 | 0 | RB | RA | 0 | 0 | | X | X | X | X | X | X | WCR9 | WCR8 | | WCR7 | WCR6 | WCR5 | WCR4 | WCR3 | WCR2 | WCR1 | WCR0 | | | |

## TRANSFER WIPER COUNTER REGISTER (WCR) TO DATA REGISTER (DR)

| START | DEVICE TYPE IDENTIFIER | | | | DEVICE ADDRESSES | | | $R/\overline{W}=0$ | SACK | INSTRUCTION OPCODE | | | | REGISTER ADDRESSES | | | | SACK | STOP | HIGH-VOLTAGE WRITE CYCLE |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| | 0 | 1 | 0 | 1 | A2 | 1 | A0 | | | 1 | 1 | 1 | 0 | RB | RA | 0 | 0 | | | |

## TRANSFER DATA REGISTER (DR) TO WIPER COUNTER REGISTER (WCR)

| START | DEVICE TYPE IDENTIFIER | | | | DEVICE ADDRESSES | | | $R/\overline{W}=1$ | SACK | INSTRUCTION OPCODE | | | | REGISTER ADDRESSES | | | | SACK | STOP |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| | 0 | 1 | 0 | 1 | A2 | A1 | A0 | | | 1 | 1 | 0 | 0 | RB | RA | 0 | 0 | | |

NOTES:

1. A2 ~ A0": stand for the device addresses sent by the master.

2. WCRx refers to wiper position data in the Wiper Counter Register

## Absolute Maximum Ratings

Voltage on SCL, SDA, or any address input
with respect to $V_{SS}$ . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -1V to +7V
$\Delta V = |\,(VH–VL)\,|$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . .5V
$I_W$ (10s) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . ±6mA

## Operating Conditions

Commercial . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 0°C to +70°C
Industrial  . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -40° to +85°C
Supply Voltage (VCC) Limits (Note 4)
    X9119 . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . .  5V ±10%
    X9119-2.7. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . .2.7V to 5.5V

## Thermal Information

Temperature under bias. . . . . . . . . . . . . . . . . . . . . . . .-65°C to +135°C
Storage temperature . . . . . . . . . . . . . . . . . . . . . . . . .-65°C to +150°C
Lead temperature (soldering, 10s). . . . . . . . . . . . . . . . . . . . . 300°C
Pb-Free Reflow Profile. . . . . . . . . . . . . . . . . . . . . . . .see link below
    http://www.intersil.com/pbfree/Pb-FreeReflow.asp

*CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.*

## Analog Specifications    (Over recommended operation conditions unless otherwise stated.)

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN (Note 8) | TYP | MAX (Note 8) | UNITS |
|---|---|---|---|---|---|---|
| End-to-End Resistance | $R_{TOTAL}$ | | | 100 | | kΩ |
| End-to-End Resistance Tolerance | | | | | ±20 | % |
| Power Rating | | +25°C, each pot | | | 50 | mW |
| Wiper Current | $I_W$ | | | | ±3 | mA |
| Wiper Resistance | $R_W$ | Wiper Current = ± 50µA, $V_{CC}$ = 5V | | 40 | 110 | Ω |
| | | Wiper Current = ± 50µA, $V_{CC}$ = 3V | | 150 | 300 | Ω |
| Voltage on any $R_H$ or $R_L$ Pin | $V_{TERM}$ | $V_{SS}$ = 0V | $V_{SS}$ | | 5 | V |
| Noise | | Ref: 1V | | -120 | | dBV |
| Resolution | | | | 0.1 | | % |
| Absolute Linearity (Note 1) | | $R_{w(n)(actual)} − R_{w(n)(expected)}$, where n = 8 to 1006 | | | ±1 | MI (Note 3) |
| | | $R_{w(n)(actual)} − R_{w(n)(expected)}$ (Note 4) | | ±1.5 | ±2.0 | MI (Note 3) |
| Relative Linearity (Note 2) | | $R_{w(m + 1)} − [R_{w(m)} + MI]$, where m = 8 to 1006 | | | ±0.5 | MI (Note 3) |
| | | $R_{w(m + 1)} − [R_{w(m)} + MI]$ (Note 4) | | ±0.5 | ±1.0 | MI (Note 3) |
| Temperature Coefficient of $R_{TOTAL}$ | | | | ±300 | | ppm/°C |
| Ratiometric Temp. Coefficient | | | | 20 | | ppm/°C |
| Potentiometer Capacitancies | $C_H/C_L/C_W$ | See Macro model | | 10/10/25 | | pF |

NOTES:

1. Absolute linearity is utilized to determine actual wiper voltage vs expected voltage as determined by wiper position when used as a potentiometer.

2. Relative linearity is utilized to determine the actual change in voltage between two successive tap positions when used as a potentiometer. It is a measure of the error in step size.

3. MI = $R_{TOT}$/1023 or $(R_H − R_L)$/1023, single pot

4. n = 0, 1, 2, …,1023; m =0, 1, 2, …, 1022.

5. ESD Rating on $R_H$, $R_L$, $R_W$ pins is 1.5kV (HBM, 1.0µA leakage maximum), ESD rating on all other pins is 2.0kV.

## Operating Specifications (Over the recommended operating conditions unless otherwise specified.)

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
|---|---|---|---|---|---|---|
| $V_{CC}$ supply current (active) | $I_{CC1}$ | $f_{SCL}$ = 400kHz; $V_{CC}$ = +5.5V; SDA = Open; (for 2-wire, Active, Read and Volatile Write States only) | | | 3 | mA |
| $V_{CC}$ supply current (nonvolatile write) | $I_{CC2}$ | $f_{SCL}$ = 400kHz; $V_{CC}$ = +5.5V; SDA = Open; (for 2-wire, Active, Non-volatile Write State only) | | | 5 | mA |
| $V_{CC}$ current (standby) | $I_{SB}$ | $V_{CC}$ = +5.5V; $V_{IN}$ = $V_{SS}$ or $V_{CC}$; SDA = $V_{CC}$; (for 2-wire, Standby State only) | | | 3 | µA |
| Input leakage current | $I_{LI}$ | $V_{IN}$ = $V_{SS}$ to $V_{CC}$ | | | 10 | µA |
| Output leakage current | $I_{LO}$ | $V_{OUT}$ = $V_{SS}$ to $V_{CC}$ | | | 10 | µA |
| Input HIGH voltage | $V_{IH}$ | | $V_{CC}$ x 0.7 | | $V_{CC}$ + 1 | V |
| Input LOW voltage | $V_{IL}$ | | -1 | | $V_{CC}$ x 0.3 | V |
| Output LOW voltage | $V_{OL}$ | $I_{OL}$ = 3mA | | | 0.4 | V |
| Output HIGH voltage | $V_{OH}$ | | | | | |

## Endurance and Data Retention

| PARAMETER | MIN | UNITS |
|---|---|---|
| Minimum Endurance | 100,000 | Data changes per bit per register |
| Data Retention | 100 | years |

## Capacitance

| TEST | SYMBOL | MAX | UNITS | TEST CONDITIONS |
|---|---|---|---|---|
| Input/Output capacitance (SI) | $C_{IN/OUT}$ (Note 6) | 8 | pF | $V_{OUT}$ = 0V |
| Input capacitance (SCL, $\overline{WP}$, A1 and A0) | $C_{IN}$ (Note 6) | 6 | pF | $V_{IN}$ = 0V |

## Power-Up Timing

| PARAMETER | SYMBOL | MIN | MAX | UNITS |
|---|---|---|---|---|
| $V_{CC}$ Power-up Rate | $t_r$ $V_{CC}$ (Note 6) | 0.2 | 50 | V/ms |
| Power-up to Initiation of read operation | $t_{PUR}$ (Note 7) | | 1 | ms |
| Power-up to Initiation of write operation | $t_{PUW}$ (Note 7) | | 50 | ms |

NOTES:

6. Limits should be considered typical and are not production tested.

7. $t_{PUR}$ and $t_{PUW}$ are the delays required from the time the (last) power supply (Vcc-) is stable until the specific instruction can be issued. These parameters are not 100% tested.

8. Parameters with MIN and/or MAX limits are 100% tested at +25°C, unless otherwise specified. Temperature limits established by characterization and are not production tested.

## AC Test Conditions

| | |
|---|---|
| Input Pulse Levels | $V_{CC}$ x 0.1 to $V_{CC}$ x 0.9 |
| Input Rise and Fall Times | 10ns |
| Input and Output Timing Level | $V_{CC}$ x 0.5 |

## *Equivalent A.C. Load Circuit*
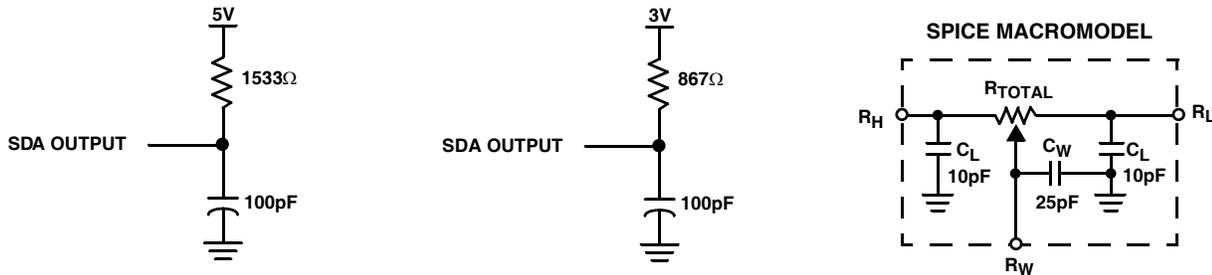


## AC Timing High-Voltage Write Cycle Timing

| PARAMETER | SYMBOL | MIN | MAX | UNITS |
|---|---|---|---|---|
| Clock Frequency | $f_{SCL}$ | | 400 | kHz |
| Clock Cycle Time | $t_{CYC}$ | 2500 | | ns |
| Clock High Time | $t_{HIGH}$ | 600 | | ns |
| Clock Low Time | $t_{LOW}$ | 1300 | | ns |
| Start Setup Time | $t_{SU:STA}$ | 600 | | ns |
| Start Hold Time | $t_{HD:STA}$ | 600 | | ns |
| Stop Setup Time | $t_{SU:STO}$ | 600 | | ns |
| SDA Data Input Setup Time | $t_{SU:DAT}$ | 100 | | ns |
| SDA Data Input Hold Time | $t_{HD:DAT}$ | 0 | | ns |
| SCL and SDA Rise Time | $t_R$ | | 300 | ns |
| SCL and SDA Fall Time | $t_F$ | | 300 | ns |
| SCL Low to SDA Data Output Valid Time | $t_{AA}$ | 250 | | ns |
| SDA Data Output Hold Time | $t_{DH}$ | 0 | | ns |
| Noise Suppression Time Constant at SCL and SDA Inputs | $T_I$ | 50 | | ns |
| Bus Free Time (Prior to Any Transmission) | $t_{BUF}$ | 1300 | | ns |
| A0, A1, A2 Setup Time | $t_{SU:WPA}$ | 0 | | ns |
| A0, A1, A2 Hold Time | $t_{HD:WPA}$ | 0 | | ns |

## High-Voltage Write Cycle Timing

| PARAMETER | SYMBOL | TYP | MAX | UNITS |
|---|---|---|---|---|
| High-Voltage Write CycleTime (Store Instructions) | $t_{WR}$ | 5 | 10 | ms |

## XDCP Timing

| PARAMETER | SYMBOL | MIN | MAX | UNITS |
|---|---|---|---|---|
| Wiper Response Time After theThird (Last) Power Supply is Stable | $t_{WRPO}$ | 5 | 10 | µs |
| WiperResponse Time After Instruction Issued (All Load Instructions) | $t_{WRL}$ | 5 | 10 | µs |

## *Symbol Table*

| WAVEFORM | INPUTS | OUTPUTS |
|---|---|---|
| | Must be steady | Will be steady |
| | May change from Low to High | Will change from Low to High |
| | May change from High to Low | Will change from High to Low |
| | Don't Care: Changes Allowed | Changing: State Not Known |
| | N/A | Center Line is High Impedance |

## *Timing Diagrams*

### *Start and Stop Timing*
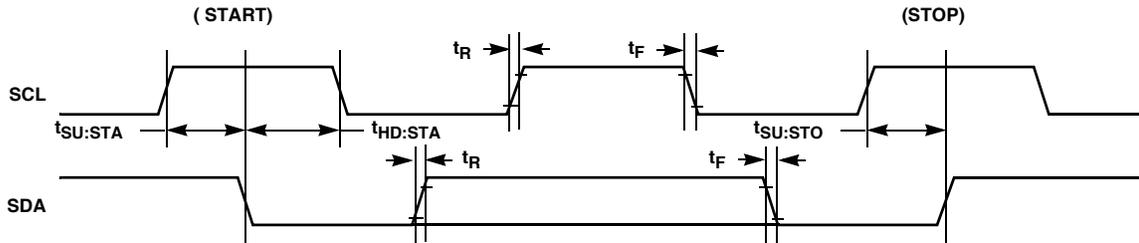
### *Input Timing*

### *Output Timing*

FN8162.4
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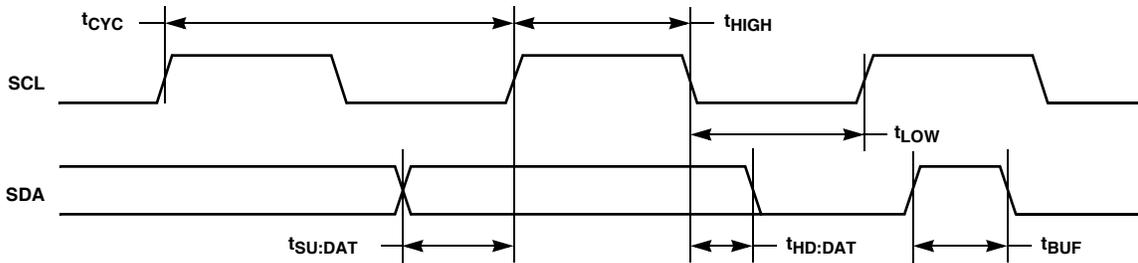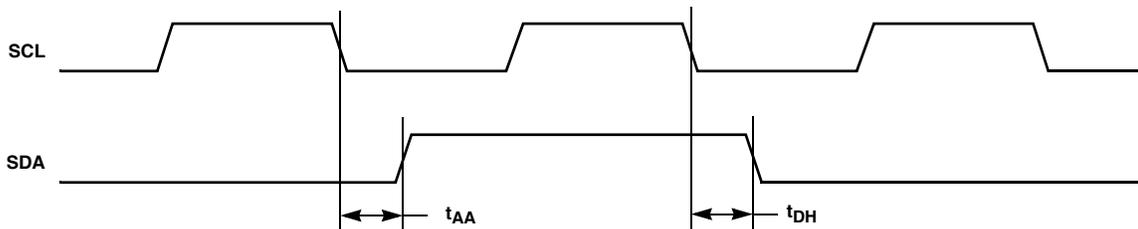
### XDCP Timing (for All Load Instructions)
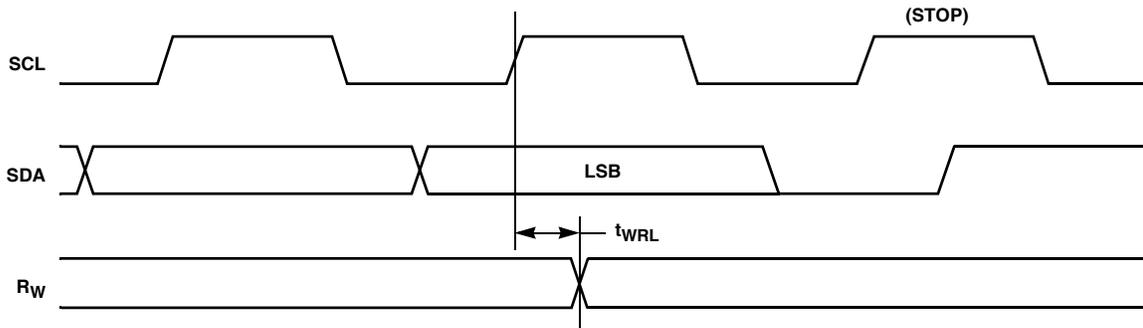


### Write Protect and Device Address Pins Timing
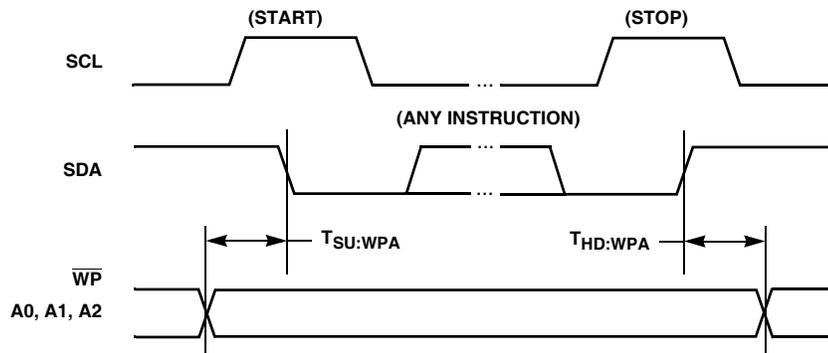
## Applications information

### Basic Configurations of Electronic Potentiometers
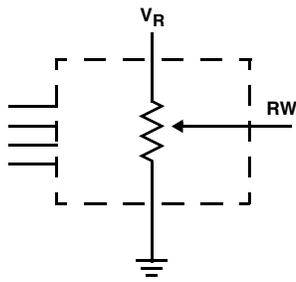


**THREE TERMINAL POTENTIOMETER;
VARIABLE VOLTAGE DIVIDER**
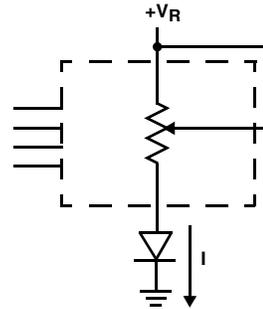


**TWO TERMINAL VARIABLE RESISTOR;
VARIABLE CURRENT**

## Application Circuits

**NONINVERTING AMPLIFIER**
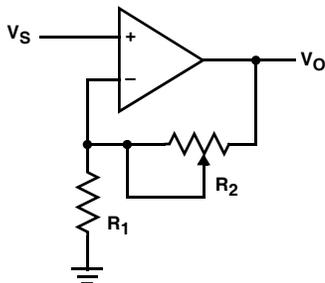


$$V_O = (1+R_2/R_1)V_S$$

**VOLTAGE REGULATOR**
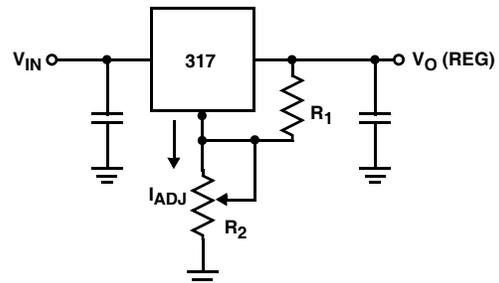


$$V_O \text{ (REG)} = 1.25V \ (1+R_2/R_1)+I_{adj} \ R_2$$

**OFFSET VOLTAGE ADJUSTMENT**
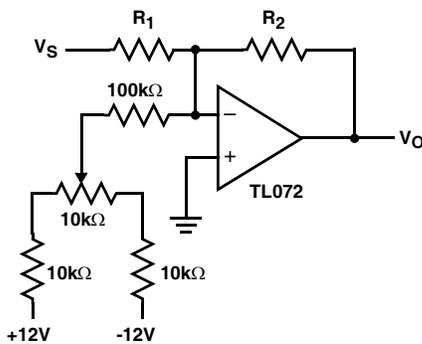


**COMPARATOR WITH HYSTERESIS**
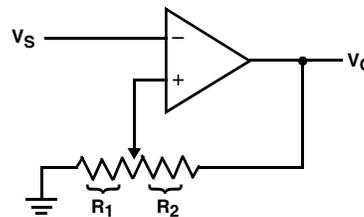


$$V_{UL} = \{R_1/(R_1+R_2)\} \ V_O(max)$$
$$RL_L = \{R_1/(R_1+R_2)\} \ V_O(min)$$

# Application Circuits (Continued)

**ATTENUATOR**
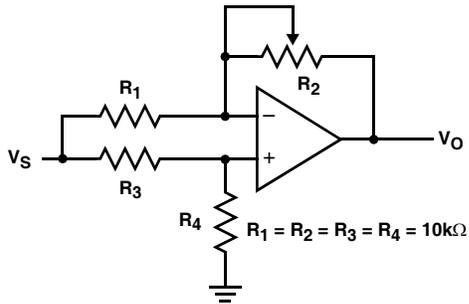


$V_O = G V_S$
$-1/2 £ G £ +1/2$

**FILTER**
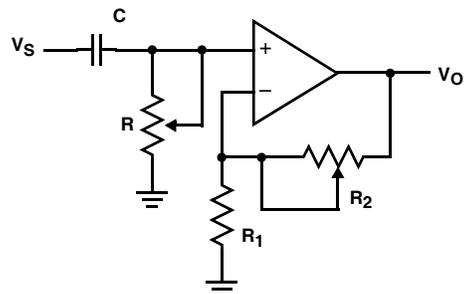


$G_O = 1 + R_2/R_1$
$fc = 1/(2pRC)$

**INVERTING AMPLIFIER**
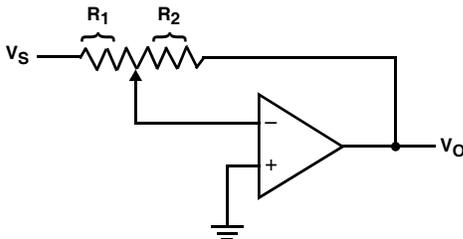


$V_O = G V_S$
$G = - R_2/R_1$

**EQUIVALENT L-R CIRCUIT**
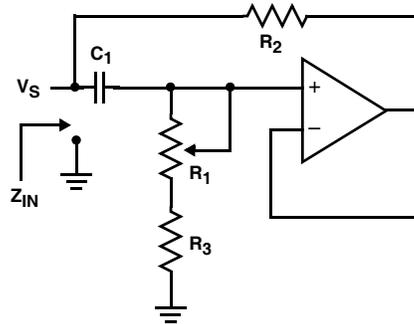


$Z_{IN} = R_2 + s R_2 (R_1 + R_3) C_1 = R_2 + s Leq$
$(R_1 + R_3) >> R_2$

**FUNCTION GENERATOR**
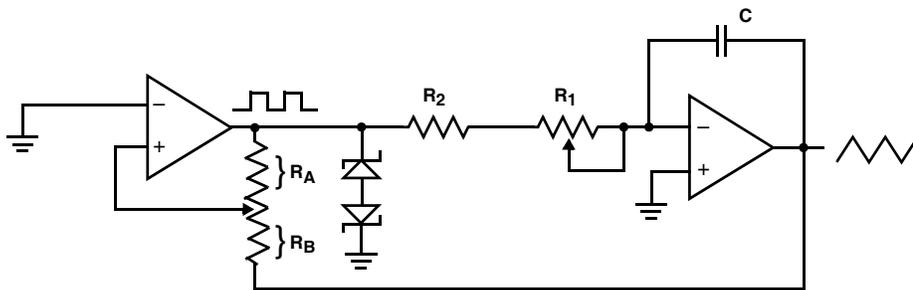


FREQUENCY $\mu$ $R_1$, $R_2$, C
AMPLITUDE $\mu$ $R_A$, $R_B$

## *Thin Shrink Small Outline Plastic Packages (TSSOP)*
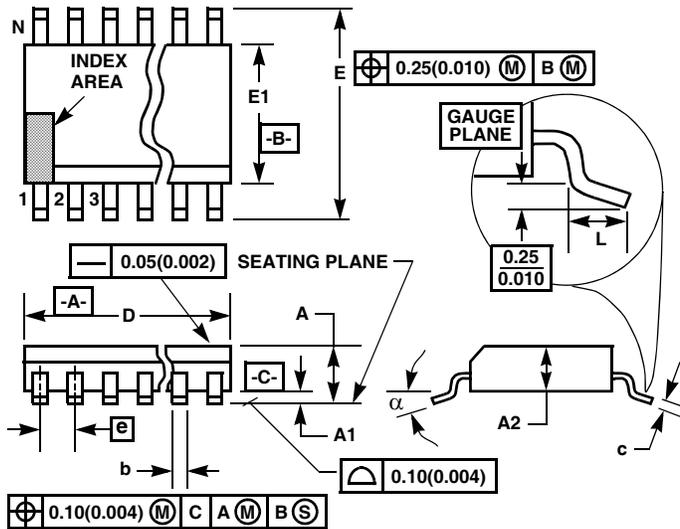


**M14.173**

**14 LEAD THIN SHRINK SMALL OUTLINE PLASTIC PACKAGE**

| SYMBOL | INCHES | | MILLIMETERS | | NOTES |
|--------|--------|--------|-------------|--------|-------|
| | MIN | MAX | MIN | MAX | |
| A | - | 0.047 | - | 1.20 | - |
| A1 | 0.002 | 0.006 | 0.05 | 0.15 | - |
| A2 | 0.031 | 0.041 | 0.80 | 1.05 | - |
| b | 0.0075 | 0.0118 | 0.19 | 0.30 | 9 |
| c | 0.0035 | 0.0079 | 0.09 | 0.20 | - |
| D | 0.195 | 0.199 | 4.95 | 5.05 | 3 |
| E1 | 0.169 | 0.177 | 4.30 | 4.50 | 4 |
| e | 0.026 BSC | | 0.65 BSC | | - |
| E | 0.246 | 0.256 | 6.25 | 6.50 | - |
| L | 0.0177 | 0.0295 | 0.45 | 0.75 | 6 |
| N | 14 | | 14 | | 7 |
| $\alpha$ | 0° | 8° | 0° | 8° | - |

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NOTES:

1. These package dimensions are within allowable dimensions of JEDEC MO-153-AC, Issue E.

2. Dimensioning and tolerancing per ANSI Y14.5M-1982.

3. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.

4. Dimension "E1" does not include interlead flash or protrusions. Inter-lead flash and protrusions shall not exceed 0.15mm (0.006 inch) per side.

5. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.

6. "L" is the length of terminal for soldering to a substrate.

7. "N" is the number of terminal positions.

8. Terminal numbers are shown for reference only.

9. Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.08mm (0.003 inch) total in excess of "b" dimension at maximum material condition. Minimum space between protrusion and adjacent lead is 0.07mm (0.0027 inch).

10. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact. (Angles in degrees)

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